

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	1296	438/106.ccls.	USPAT	OR	OFF	2005/05/13 13:36
L2	435	438/112.ccls.	USPAT	OR	OFF	2005/05/13 13:36
L3	1040	438/118.ccls.	USPAT	OR	OFF	2005/05/13 13:36
L4	969	438/127.ccls.	USPAT	OR	OFF	2005/05/13 13:36
L5	1114	257/686.ccls.	USPAT	OR	OFF	2005/05/13 13:37
L6	13	fay-owen\$.in. amrine-craig\$.in. lish-kevin\$.in.	USPAT	OR	OFF	2005/05/13 13:38
L7	8	fay-owen\$.in. amrine-craig\$.in. lish-kevin\$.in.	US-PGPUB	OR	OFF	2005/05/13 13:38
L8	4	fay-owen\$.in. amrine-craig\$.in. lish-kevin\$.in.	EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/05/13 13:38
L9	13102	porou\$6 and encapsulat\$6	USPAT	OR	ON	2005/05/13 13:39
L10	2776	9 and (porou\$6 same encapsulat\$6)	USPAT	OR	ON	2005/05/13 13:40
L11	2135	10 and (carrier die circuit chip substrate wafer)	USPAT	OR	ON	2005/05/13 13:40
L12	1079	11 and adhes\$6	USPAT	OR	ON	2005/05/13 13:42
L13	6501	(porou\$6 and encapsulat\$6) and (chip circuit die substrate carrier wafer)	US-PGPUB	OR	ON	2005/05/13 13:42
L14	1160	13 and (porou\$6 same encapsulat\$6)	US-PGPUB	OR	ON	2005/05/13 13:42
L15	755	14 and adhes\$6	US-PGPUB	OR	ON	2005/05/13 13:42
L16	204	(porou\$6 and encapsulat\$6) and (chip circuit die substrate carrier wafer)	EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/13 13:42

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